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PATENT TRADEMARK OFFICE

September 28, 2000

Box PATENT APPLICATION

Assistant Commissioner for Patents Re: New U.S. Patent Appln.
Washington, D.C. 20231 Our Ref: 2022/48819

Sir:

Transmitted herewith for filing is the patent application of:

Bulent M. Basol; Cyprian E. Uzoh; and Homayoun Talieh

entitled: **PROCESS TO MINIMIZE AND/OR ELIMINATE CONDUCTIVE
MATERIAL COATING OVER THE TOP SURFACE OF A PATTERNED
SUBSTRATE AND LAYER STRUCTURE MADE THEREBY**

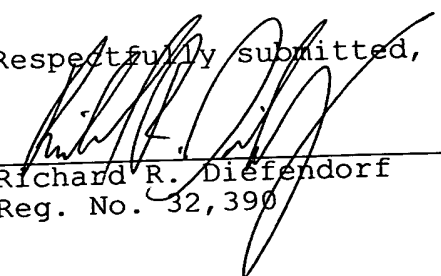
Enclosed are:

1. Specification, including 22 claims and Abstract of the Disclosure (30 pages).
2. 5 Sheets of Formal drawings showing Figs. 1-16.
3. Declaration and Power of Attorney (**executed**).
4. Verified Statement (Declaration) Claiming Small Entity Status.
5. Information Disclosure Statement & Form PTO-1449 with 30 references.
6. Assignment of the invention to Nu Tool Inc.
7. The filing fee has been calculated as shown below:

Basic Fee					\$345/690 =	\$345.00
Total Claims	<u>22</u>	- 20 =	<u>2</u>	x	\$ 9/18 =	\$ 18.00
Independent Claims	<u>2</u>	- 3 =	<u>0</u>	x	\$39/78 =	\$
Multiple Dependent Claim Presented					\$130/260 =	\$
Total Filing Fee						<u>\$363.00</u>

Two checks in the amount of \$363.00 for the filing fee and \$40.00 for the assignment recording fee are enclosed. The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment, to Deposit Account No. 05-1323 (Docket 2022/48819). A duplicate copy of this sheet is enclosed.

Respectfully submitted,


Richard R. Diefendorf
Reg. No. 32,390

RRD:msy